



SG901-1078 ADVANCE INFORMATION

SG901-1078 Miniature Wi-Fi Radio

Overview

The SG901-1078 WiFi module is a shielded and FCC certified version of the SG901-1071 Radio Module. It is optimized to simplify successful integration into systems requiring the latest performance with small size. This certified module is a highly integrated single chip based 802.11b/g/n WLAN radio for embedded, low-power and extremely small form factor mobile applications. The product conforms to the IEEE 802.11B, G, and N protocols operating in the 2.45GHz ISM frequency band supporting 802.11n modulations up to 72.2Mbps, all 802.11g OFDM modulations, and all mandatory 802.11b modulations.

The SG901-1078 is a fully integrated wireless radio including RF Synthesizer/VCO, high-speed data converters, digital baseband processor, onboard MAC and PHY processors, Power Management, Power Amplifier, and LNA.

An on-board EEPROM stores calibration data for alignment-free integration. No customer calibration required.

An on-board crystal and filter simplify system integration. The addition of 1.8V, 3.3V, and VIHO supplies, Antenna, and host communication, provides a complete WiFi solution.

Host control is provided by either an SDIO or SPI interface.



Shield not shown

Features

- FCC Module Certification
- Small Footprint (21.3 by 13.5mm)
- Factory Calibrated
- RoHs Compliant
- Fully Integrated 802.11 System Solution
- Ultra Low Current Consumption, 2.5 m A DITM = 1
- Fully Compliant with the IEEE 802.11B,G, and N WLAN Standards
- Support for 802.11n Modulations up to 72.2Mbps, and all 802.11g and Mandatory 802.11b Modulations
- Intelligent Power Control, Including 802.11 Power Save Mode
- Supports SPI Interface and SDIO Interface
- Factory Support for Linux 2.6/Android, Windows CE
- Source Code Available for porting to RTOS or Custom OS
- Hardware driver is provided under GPL
- Flexible I/O Voltage

Applications

- Hand-held Devices
- Embedded Systems
- Portable Systems
- Point of Sale terminals
- Personal Digital Assistants (PDA)
- Cameras
- Cable Replacement

Ordering Information

Packaging	Temp Range	Part Number
Tape and Reel	Extended	SG901-1078-ET-TR
Bulk	Extended	SG901-1078-ET-BLK
Tape and Reel	Commercial	SG901-1078-CT-TR
Bulk	Commercial	SG901-1078-CT-BLK

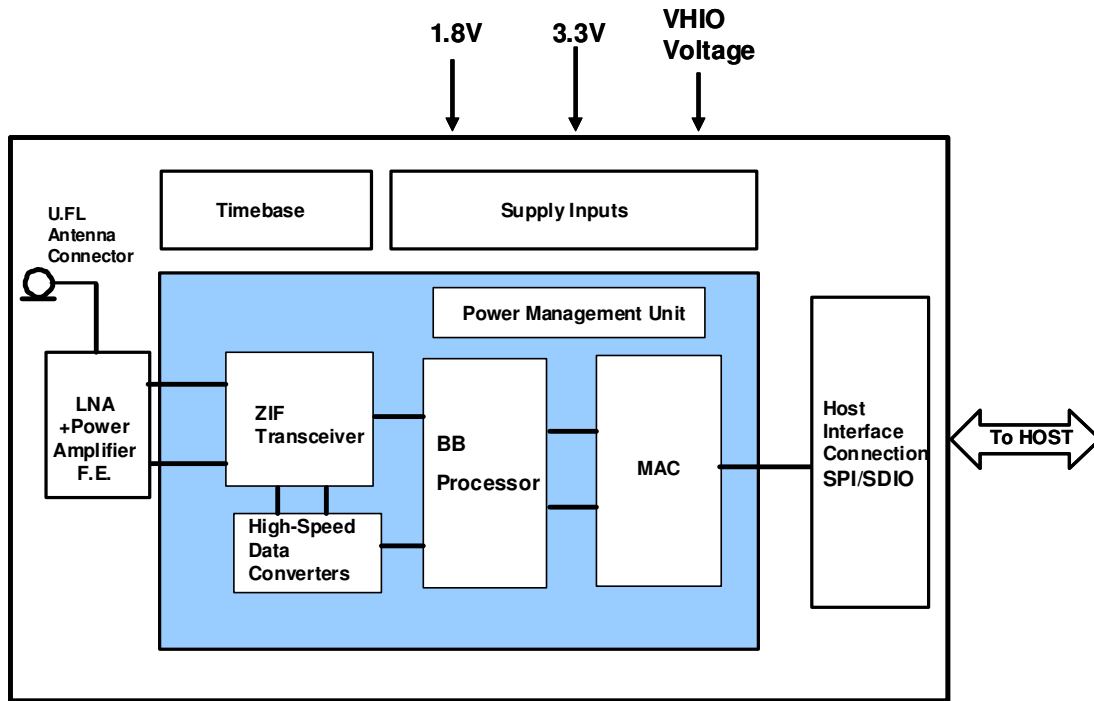
Evaluation Kit Available

This EVK supports embedded software development. Uses the SG901-1071 module.

EVK for 1071	SG923-0007
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Block Diagram



FCC Certification

		Comment
FCC ID	TB obtained	
Certified for use with these Antennas	W1038	Pulse Antennas 2.4 – 2.5 GHz with Reverse SMA connector
	W1037	Pulse Antennas 2.4 – 2.5 GHz with Reverse SMA connector
	MLPV2400NGP	PCTEL Ant 2.4 – 2.5 GHz with reverse SMA
	13018-1	Beijing Evercommunication Ant 2.4 – 2.5 GHz with IPX (U.F.L Compatible, recommended for cost sensitive applications)
Other Antennas		Additional Antennas may be added to the approval list at additional cost. Contact Sagrad for additional information



General Electrical Specifications

Parameter		Test Condition / Comment	Min.	Typ.	Max.	Units
Absolute Maximum Ratings						
3.3V Supply			-0.3		3.6	V
VLDO Supply			-0.3		2.5	V
Operating Conditions and Input Power Specifications						
Operating Temperature Range		ET Version (Extended Temperature)	-30		85	°C
		CT Version (Commercial Temperature)	0		70	°C
3.3V Supply	Input Supply Voltage	3.3V Supply input	2.7	3.3	3.6	V
	Standby Mode Current	32.768kHz Mode		270		µA
	Power Save Mode Current	DTIM = 1		2.5		mA
	Peak TX Current			270		mA
	Peak RX Current	Processing Beacons			82	mA
	Peak RX Current	Processing OFDM Packets			135	mA
Power Save Mode Settling Times	Wake up Time	From 32.768KHz Mode		5		mS
	Ramp up	To Processing Beacons		360		µS
	Ramp Down	To Stand By 32.768KHz mode		760		µS
VHIO Supply	Input Supply Voltage	VHIO input supply determines Host CMOS logic levels	1.7		3.3	V
	Input Supply Current	VHIO = 1.8V		1		mA
	Standby Mode Current	VHIO = 1.8V		100		µA
VLDO Supply	Input Supply Voltage	Required Internal regulator supply input	1.45		2.0	V
Input Voltage Levels	VIL		-0.3		0.25VHIO	V
	VIH		0.625VHIO		VHIO+0.3	V
Output Voltage Levels	VOL	IOL = 8.0mA			0.4	V
	VOH	IOH = -8.0mA	0.75VHIO		VHIO	V
Input Capacitance			1.0		5.0	pF



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RF Characteristics (Max and Min based on temperature range)

Parameter		Test Condition / Comment	Min.	Typ.	Max.	Units
Antenna Port Impedance				50		Ohms
Antenna Input Return Loss		CH1 to CH14	-9.5		-14	dB
RX Sensitivity	11b, 1Mbps		-97	-96.3	-95	dBm
	11b, 2 Mbps		-94	-93.5	-91	dBm
	11b, 5.5 Mbps		-93	-91	-88	dBm
	11b, 11 Mbps		-89	-86.7	-85	dBm
	11g, 9Mbps		-92	-89.6	-88	dBm
	11g, 18Mbps		-87	-85.9	-84	dBm
	11g, 36Mbps		-80	-78.6	-77	dBm
	11g, 54Mbps		-74	-72.4	-70	dBm
	11n, MCS1			-86		dBm
	11n, MCS3			-80		dBm
	11n, MCS5			-72		dBm
11n, MCS7			-69		dBm	
Channel to Channel De-sensitivity	CH1 to 14	11g, 54Mbps 10% PER	-0.7		0.7	dB
Maximum Input Signal	CH7	11g, 54Mbps	-19		-16	dBm
Adjacent Channel Rejection	1Mbps			50		
	11Mbps			47		
	9Mbps			25		dB
	54Mbps			13		dB
	MCS1			24		dB
	MCS7			5		dB
TX Output Power	11b, 1Mbps	@802.11b spectral mask	15	16.5	19.1	dBm
	11b, 11Mbps		15.5	16.2	19.4	dBm
	11g, 9Mbps	@802.11g spectral mask	17	18.2	19.5	dBm
	11g, 54Mbps	EVM = -27dB, 4.5%	11.7	13.4	15.1	dBm
	802.11n MCS1	@802.11n spectral mask		17		dBm
	802.11n MCS7	EVM = -27dB		13		dBm



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Pinout List

SIGNAL NAME	PIN NUMBER	DESCRIPTION	NOTES
RF Pins			
2G4_RF	U.FL Connector		Hirose Electrical PN U.FL-R-SMT(10)
2G4_RF	11	Optional PAD, Factory enabled only	Careful Layout for this RF Pad and nearby ground
Serial Interface Pins (VHIO Domain, logic levels compatible with the VHIO (Pin 26) input voltage)			
SDCMD	21	SPI MOSI (input)	SDIO CMD VHIO Domain
SDCLK	22	SPI Clock Input	SDIO CLK VHIO Domain
SDD0	20	SPI MISO (output)	SDIO Data 0 VHIO Domain
SDD1	19	SPI: Interrupt Output	SDIO Data 1 VHIO Domain
SDD2	18		SDIO Data 2 VHIO Domain
SDD3	17	SPI Chip Select Input	SDIO Data 3 VHIO Domain
Control Pins			
POWERUP	4	Power Up Enable (from Host)	VLDO Domain with internal pull up High = operating, Low = off
RSTn	25	Reset Input	VHIO Domain – Active Low reset
CLK32K	27	32.768 kHz Sleep Clock Input	VHIO Domain
Power and Ground Pins			
VHIO	26	Supply Voltage for I/O's	1.7 to 3.3V, Internally decoupled with a 0.1uF capacitor
VLDO	9	External regulator supply input	1.45 to 2.0V, Internally decoupled with a 10uF capacitor
3.3V	8	RF PA supply	2.7 to 3.3V, Internally decoupled with a 10uF capacitor
GND	1,2,3,5,6,7,10, 12,13,14,15,16, 23,24,28,Paddle	Ground Connections	



Software Support

The 1071 and 1078 modules are supported through highly portable software. The hardware drivers and Wi-Fi stack as provided is compatible with Linux kernel 2.6. The source code for the hardware abstraction is available under a GPL license and is available from Sagrad. The licensed Wi-Fi licensed stack available from Sagrad is provided in binary form without a license. Source code for the Wi-Fi stack is available to the customer. To obtain source code for the stack contact Sagrad sales at www.sagrad.com. Software and source code are available free of charge but require a software license agreement for the Wi-Fi stack source.

In almost all cases the GPL driver will need to be modified for the customer's specific hardware. The Wi-Fi stack will only need to be modified for compatibility to the customers OS and compiler. In many cases such as Linux near zero modification of the Wi-Fi stack will be required.

The Wi-Fi module/stack currently is only tested in client mode and is compatible with any access point that meets 802.11 standards. An access point mode code base is planned in the future.

The complete 802.11 stack requires about 350KB of space for the implementation of the entire specification. Extremely small versions can be created by knowledgeable customers but is a considerable task and requires detailed understanding of 802.11.

As a service to customers, Sagrad offers extended technical support on a fee basis.



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Software Details:

MAC

- Comprehensive MAC functionality according to IEEE 802.11-2007, including QoS traffic scheduling
 - Supports the following optional IEEE 802.11n features:
 - MPDU aggregation
 - MSDU aggregation
 - Immediate Block Acknowledgement
 - PSMP
 - MTBA
 - RIFS
 - L-SIG TXOP protection
- Link adaptation using MCS feedback

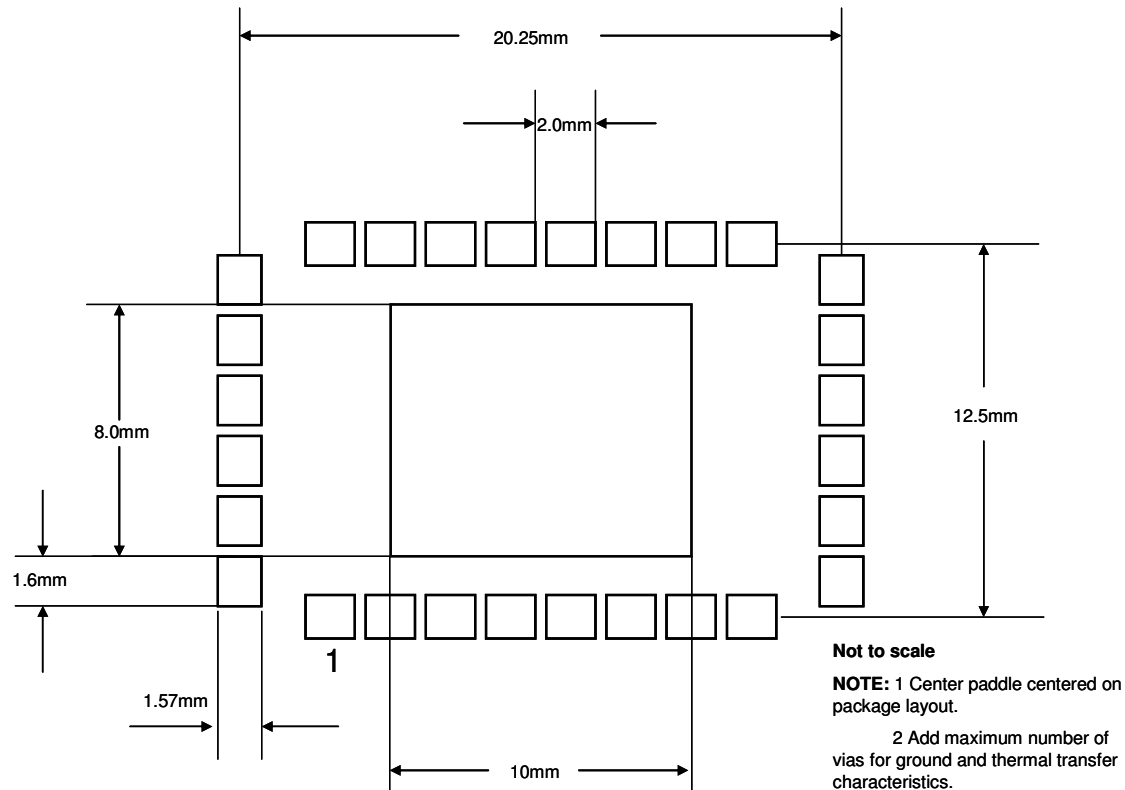
Encryption

- Hardware encryption according to IEEE 802.11-2007 and IEEE 802.11w/D10.0:
 - WEP40/64
 - WEP104/128
 - CCMP (AES)
 - TKIP
 - BIP
- Hardware encryption support for SMS4 to support WAPI
- Hardware encryption support for Cisco® CKIP

OS Support:

Windows Mobile 7 and 6.x, Windows CE 6.1 and 5, Linux v2.6, Android

Recommended Layout



PCB design requires detailed review of the center exposed pad. This pad requires good thermal conductivity. Soldering coverage should be maximized and checked via x-ray for proper design. There is a trade off in providing enough solder for conductivity, and too much which allows the module to “float” on the paddle creating reliability issues. Sagrad recommends two approaches, a large center via that allows excess soldering to flow down into the host PCB with smaller vias around it. Or many smaller vias with just enough space for the viscosity of the chosen solder/flux to allow some solder to flow into the smaller vias. Each of these approaches need to result in 60% or more full contact solder coverage on the paddle after reflow. Sagrad strongly encourages PCB layout teams to work with their EMS providers to insure vias and solder paste designs will result in satisfactory performance.

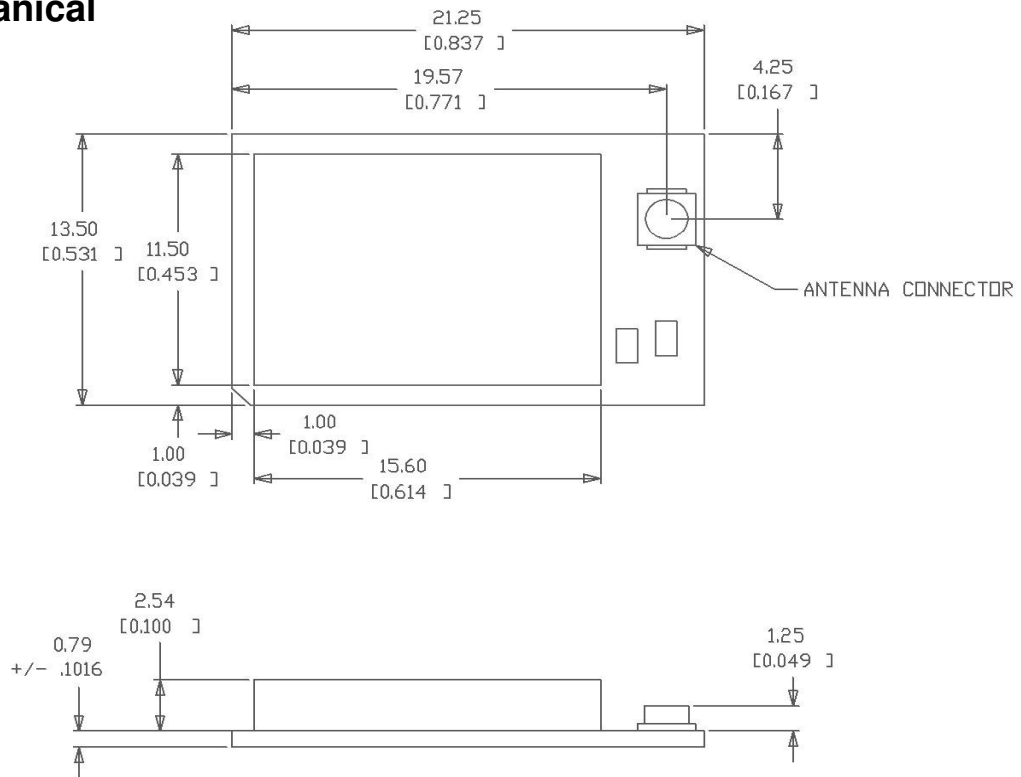
Note: Pin one is on the bottom left of this diagram.

This view is viewed from the top.

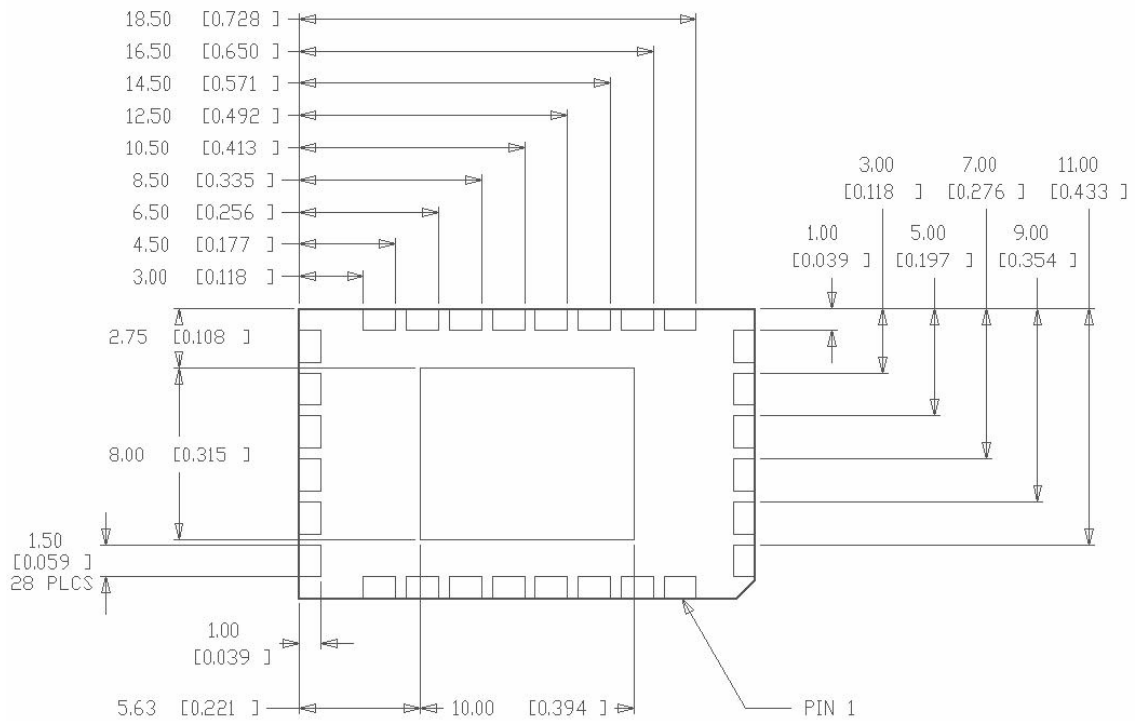


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Mechanical



TOP VIEW



BOTTOM VIEW



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Packaging

The part comes packaged in Tape and Reel or bulk.